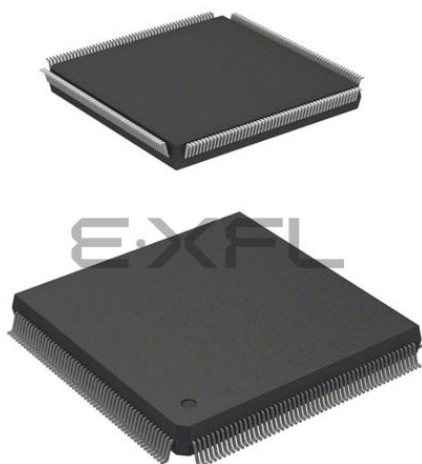




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	2625
Number of Logic Elements/Cells	21000
Total RAM Bits	282624
Number of I/O	131
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-20e-7q208c

Table 1-2. LatticeECP2M (Including “S-Series”) Family Selection

Device	ECP2M20	ECP2M35	ECP2M50	ECP2M70	ECP2M100
LUTs (K)	19	34	48	67	95
sysMEM Blocks (18kb)	66	114	225	246	288
Embedded Memory (Kbits)	1217	2101	4147	4534	5308
Distributed Memory (Kbits)	41	71	101	145	202
sysDSP Blocks	6	8	22	24	42
18x18 Multipliers	24	32	88	96	168
GPLL+SPLL+DLL	2+6+2	2+6+2	2+6+2	2+6+2	2+6+2
Maximum Available I/O	304	410	410	436	520
Packages and SERDES / I/O Combinations					
256-ball fpBGA (17 x 17 mm)	4 / 140	4 / 140			
484-ball fpBGA (23 x 23 mm)	4 / 304	4 / 303	4 / 270		
672-ball fpBGA (27 x 27 mm)		4 / 410	8 / 372		
900-ball fpBGA (31 x 31 mm)			8 / 410	16 / 416	16 / 416
1152-ball fpBGA (35 x 35 mm)				16 / 436	16 / 520

Introduction

The LatticeECP2/M family of FPGA devices is optimized to deliver high performance features such as advanced DSP blocks, high speed SERDES (LatticeECP2M family only) and high speed source synchronous interfaces in an economical FPGA fabric. This combination was achieved through advances in device architecture and the use of 90nm technology.

The LatticeECP2/M FPGA fabric is optimized with high performance and low cost in mind. The LatticeECP2/M devices include LUT-based logic, distributed and embedded memory, Phase Locked Loops (PLLs), Delay Locked Loops (DLLs), pre-engineered source synchronous I/O support, enhanced sysDSP blocks and advanced configuration support, including encryption (“S” versions only) and dual boot capabilities.

The LatticeECP2M device family features high speed SERDES with PCS. These high jitter tolerance and low transmission jitter SERDES with PCS blocks can be configured to support an array of popular data protocols including PCI Express, Ethernet (1GbE and SGMII), OBSAI and CPRI. Transmit Pre-emphasis and Receive Equalization settings make SERDES suitable for chip to chip and small form factor backplane applications.

Lattice Diamond® design software allows large complex designs to be efficiently implemented using the LatticeECP2/M FPGA family. Synthesis library support for LatticeECP2/M is available for popular logic synthesis tools. The Diamond software uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeECP2/M device. The Diamond design tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-engineered IP (Intellectual Property) modules for the LatticeECP2/M family. By using these IP cores as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

Delay Locked Loops (DLL)

In addition to PLLs, the LatticeECP2/M family of devices has two DLLs per device.

CLKI is the input frequency (generated either from the pin or routing) for the DLL. CLKI feeds into the output muxes block to bypass the DLL, directly to the DELAY CHAIN block and (directly or through divider circuit) to the reference input of the Phase Frequency Detector (PFD) input mux. The reference signal for the PFD can also be generated from the Delay Chain and CLKFB signals. The feedback input to the PFD is generated from the CLKFB pin, CLKI or from tapped signal from the Delay chain.

The PFD produces a binary number proportional to the phase and frequency difference between the reference and feedback signals. This binary output of the PFD is fed into a Arithmetic Logic Unit (ALU). Based on these inputs, the ALU determines the correct digital control codes to send to the delay chain in order to better match the reference and feedback signals. This digital code from the ALU is also transmitted via the Digital Control bus (DCNTL) bus to its associated DLLDELA delay block. The ALUHOLD input allows the user to suspend the ALU output at its current value. The UDDCNTL signal allows the user to latch the current value on the DCNTL bus.

The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. Both the CLKOS and CLKOP outputs are available with optional duty cycle correction. Divide by two and divide by four frequencies are available at CLKOS. The LOCK output signal is asserted when the DLL is locked. Figure 2-6 shows the DLL block diagram and Table 2-5 provides a description of the DLL inputs and outputs.

The user can configure the DLL for many common functions such as time reference delay mode and clock injection removal mode. Lattice provides primitives in its design tools for these functions. For more information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-6. Delay Locked Loop Diagram (DLL)

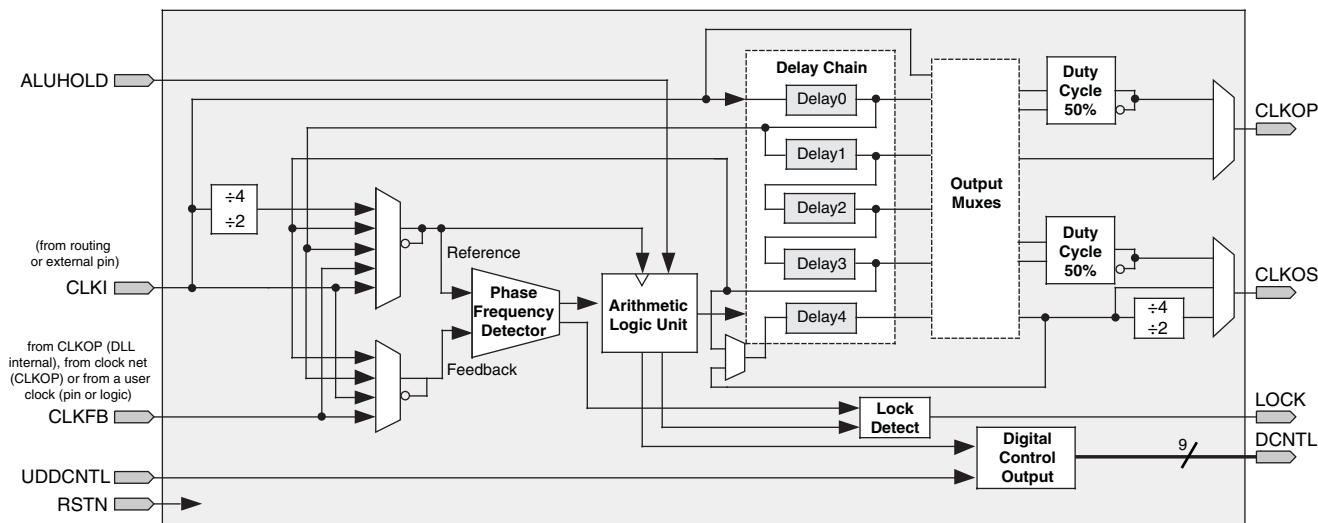
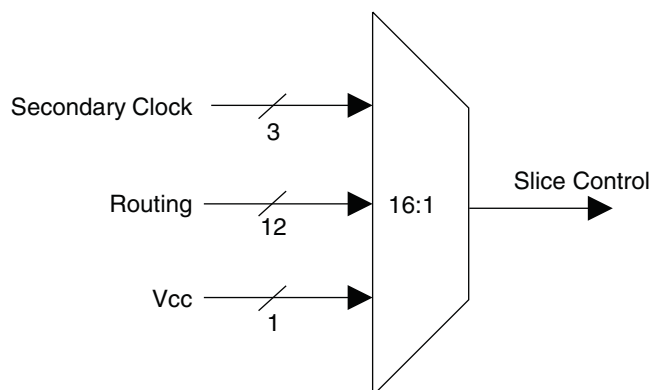


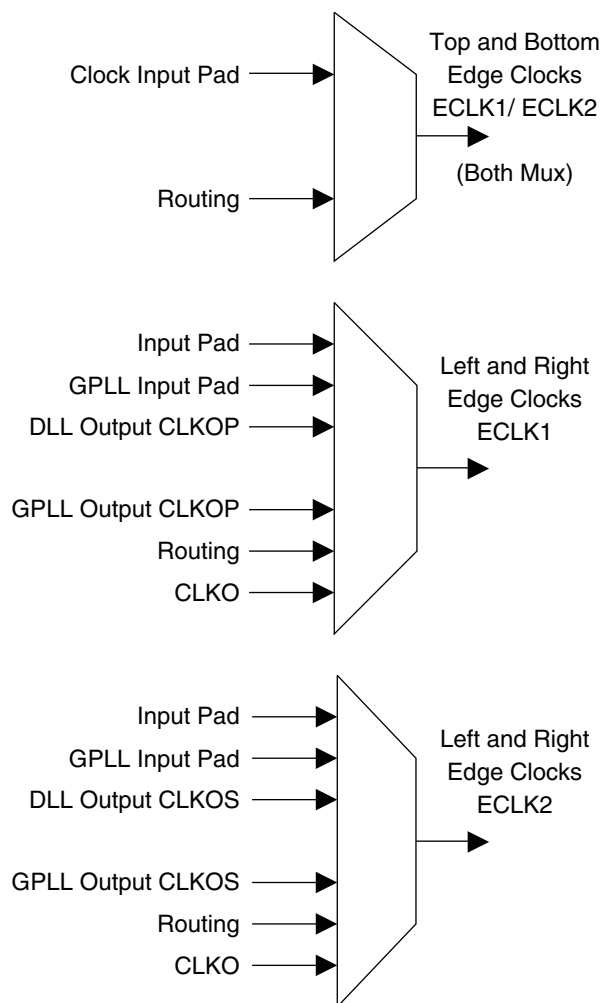
Figure 2-18. Slice0 through Slice2 Control Selection



Edge Clock Routing

LatticeECP2/M devices have a number of high-speed edge clocks that are intended for use with the PIOs in the implementation of high-speed interfaces. There are eight edge clocks per device: two edge clocks per edge. Different PLL and DLL outputs are routed to the two muxes on the left and right sides of the device. In addition, the CLKO signal (generated from the DLLDELA block) is routed to all the edge clock muxes on the left and right sides of the device. Figure 2-19 shows the selection muxes for these clocks.

Figure 2-19. Edge Clock Mux Connections



The diagram illustrates the DQS strobe calibration logic, showing the interaction between various signals and internal blocks:

- Inputs:** CLK1, ECLK2, ECLK1, DQSXFER, DCNTL[6:0], Polarity control, DQS, DQSXFERDEL*, and a Calibration bus from DLL.
- Top PIO Block:** Contains an Output Register Block, an Input Register Block, and a multiplexer. It receives DQSXFER, DQS, and DCNTL[6:0]. The multiplexer selects between the Input Register Block and the Input Register Block (To Sync Reg.) to output to the DDR Datin PAD.
- Middle PIO Block:** Contains Polarity Control Logic and DQSDEL. It receives DQS, DCNTL[6:0], and the Calibration bus from DLL. The Polarity Control Logic outputs to the DQSDEL block.
- Bottom Block:** Contains DQSXFERDEL*. It receives DQSXFER and DCNTL[6:0] signals.
- sysIO Buffers:** Two buffers are shown, one for the DDR Datin PAD and one for the DQS Strobe PAD. Both buffers have a DI input.

Polarity Control Logic

The LatticeECP2/M family contains dedicated circuits to transfer data between these domains. To prevent set-up and hold violations, at the domain transfer between DQS (delayed) and the system clock, a clock polarity selector is used. This changes the edge on which the data is registered in the synchronizing registers in the input register block. This requires evaluation at the start of each READ cycle for the correct clock polarity.

Prior to the READ operation in DDR memories, DQS is in tristate (pulled by termination). The DDR memory device drives DQS low at the start of the preamble state. A dedicated circuit detects the first DQS rising edge after the preamble state. This signal is used to control the polarity of the clock to the synchronizing registers.

Symbol	Parameter	Min.	Max.	Units
V_{CCP}^6	PLL and Reference Clock Buffer Power	1.14	1.26	V

1. If V_{CCIO} or V_{CCJ} is set to 1.2V, they must be connected to the same power supply as V_{CC} . If V_{CCIO} or V_{CCJ} is set to 3.3V, they must be connected to the same power supply as V_{CCAUX} . V_{CCPLL} must be connected to the same power supply as V_{CC} through careful filtering and decoupling.
2. See recommended voltages by I/O standard in subsequent table.
3. V_{CCAUX} ramp rate must not exceed 30mV/ μ s during power-up when transitioning between 0V and 3.3V.
4. For proper power-up configuration, users must ensure that the configuration control signals such as the CFGx, INITN, PROGRAMN and DONE pins are driven to the proper logic levels when the device powers up. The device power-up is triggered by the last of V_{CC} , V_{CCAUX} or V_{CCIO8} supplies that reaches its minimum valid levels. Alternatively, if the configuration control signals are pulled up by V_{CCIO8} , the V_{CCIO8} (configuration I/O bank) voltage must be powered up prior to or at the same time as the last of V_{CC} or V_{CCAUX} reaches its minimum levels.
5. For power-up, V_{CC} must reach its valid minimum value before powering up V_{CCAUX} (LatticeECP2/M "S" version devices only).
6. V_{CCRX} , V_{CCTX} and V_{CCP} must be tied together in each quad and all quads need to be powered up.
7. For more power supply design recommendations, refer to TN1114 [Electrical Recommendations for Lattice SERDES](#).

Hot Socketing Specifications^{1, 2, 3, 4}

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{DK}	Input or I/O leakage current	$0 \leq V_{IN} \leq V_{IH} \text{ (MAX.)}$	—	—	+/-1000	μ A
I_{HDIN}^5	SERDES average input current when device is powered down and inputs are driven		—	—	4	mA

1. V_{CC} , V_{CCAUX} and V_{CCIO} should rise/fall monotonically. V_{CC} and V_{CCPLL} must be connected to the same power supply (applies to ECP2-6, ECP2-12 and ECP2-20 only).
2. $0 \leq V_{CC} \leq V_{CC} \text{ (MAX.)}$, $0 \leq V_{CCIO} \leq V_{CCIO} \text{ (MAX.)}$ or $0 \leq V_{CCAUX} \leq V_{CCAUX} \text{ (MAX.)}$.
3. I_{DK} is additive to I_{PU} , I_{PW} or I_{BH} .
4. LVCMOS and LVTTL only.
5. Assumes that the device is powered down with all supplies grounded, both P and N inputs driven by a CML driver with maximum allowed V_{CCIB} of 1.575V, 8b10b data and internal AC coupling.

ESD Performance

Please refer to [LatticeECP2/M Product Family Qualification Summary](#) for complete qualification data, including ESD performance.

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{HPLL}	Clock to Data Hold - PIO Input Register	LFE2-6	1.00	—	1.20	—	1.40	—	ns
		LFE2-12	1.00	—	1.20	—	1.40	—	ns
		LFE2-20	1.00	—	1.20	—	1.40	—	ns
		LFE2-35	1.00	—	1.20	—	1.40	—	ns
		LFE2-50	1.00	—	1.20	—	1.40	—	ns
		LFE2-70	1.00	—	1.20	—	1.40	—	ns
		LFE2M20	1.00	—	1.20	—	1.40	—	ns
		LFE2M35	1.00	—	1.20	—	1.40	—	ns
		LFE2M50	1.00	—	1.20	—	1.40	—	ns
		LFE2M70	1.00	—	1.20	—	1.40	—	ns
		LFE2M100	1.00	—	1.20	—	1.40	—	ns
t _{SU_DELPLL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.80	—	2.00	—	2.20	—	ns
		LFE2-12	1.80	—	2.00	—	2.20	—	ns
		LFE2-20	1.80	—	2.00	—	2.20	—	ns
		LFE2-35	1.80	—	2.00	—	2.20	—	ns
		LFE2-50	1.80	—	2.00	—	2.20	—	ns
		LFE2-70	1.80	—	2.00	—	2.20	—	ns
		LFE2M20	1.80	—	2.00	—	2.20	—	ns
		LFE2M35	1.80	—	2.00	—	2.20	—	ns
		LFE2M50	1.90	—	2.10	—	2.30	—	ns
		LFE2M70	1.90	—	2.10	—	2.30	—	ns
		LFE2M100	2.00	—	2.20	—	2.40	—	ns
t _{H_DELPLL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns

DDR I/O Pin Parameters²

t _{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t _{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI
t _{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t _{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f _{MAX_DDR}	DDR Clock Frequency ⁶	ECP2/M	95	200	95	166	95	133	MHz

DDR2 I/O Pin Parameters³

t _{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t _{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N15	GND	-			GND	-		
N17	GND	-			GND	-		
P10	GND	-			GND	-		
P12	GND	-			GND	-		
P13	GND	-			GND	-		
P14	GND	-			GND	-		
P15	GND	-			GND	-		
P17	GND	-			GND	-		
R13	GND	-			GND	-		
R14	GND	-			GND	-		
T10	GND	-			GND	-		
T11	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T24	GND	-			GND	-		
T3	GND	-			GND	-		
U10	GND	-			GND	-		
U11	GND	-			GND	-		
U13	GND	-			GND	-		
U14	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
V13	GND	-			GND	-		
V14	GND	-			GND	-		
V21	GND	-			GND	-		
V6	GND	-			GND	-		
M3	NC	-			NC	-		
N6	NC	-			NC	-		
P24	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AH24	PB89A	4	BDQ87	T
AH25	PB89B	4	BDQ87	C
VCCIO	VCCIO4	4		
AJ26	PB90A	4	BDQ87	T
AK26	PB90B	4	BDQ87	C
AF25	PB91A	4	BDQ87	T
AG25	PB91B	4	BDQ87	C
GND	GNDIO4	-		
AK22	PB92A	4	BDQ96	T
AJ22	PB92B	4	BDQ96	C
AE22	PB93A	4	BDQ96	T
AF22	PB93B	4	BDQ96	C
AG22	PB94A	4	BDQ96	T
VCCIO	VCCIO4	4		
AH22	PB94B	4	BDQ96	C
AG24	PB95A	4	BDQ96	T
AG23	PB95B	4	BDQ96	C
AE23	PB96A	4	BDQS96	
GND	GNDIO4	-		
AC22	PB97A	4	BDQ96	
AJ23	PB98A	4	BDQ96	T
VCCIO	VCCIO4	4		
AK23	PB98B	4	BDQ96	C
AD24	PB99A	4	BDQ96	T
AF24	PB99B	4	BDQ96	C
AC23	PB100A	4	VREF2_4/BDQ96	T
GND	GNDIO4	-		
AE24	PB100B	4	VREF1_4/BDQ96	C
AE25	CFG2	8		
AB22	CFG1	8		
AE26	CFG0	8		
AA22	PROGRAMN	8		
AD25	CCLK	8		
AD26	INITN	8		
AC24	DONE	8		
GND	GNDIO4	-		
AC25	PR90B	8	WRITEN	C
AE27	PR90A	8	CS1N	T
AC26	PR89B	8	CSN	C
AE28	PR89A	8	D0/SPIFASTN	T
VCCIO	VCCIO8	8		
AD27	PR88B	8	D1	C
AD28	PR88A	8	D2	T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AG4	NC	-		
AG8	NC	-		
AH1	NC	-		
AH16	NC	-		
AH2	NC	-		
AH26	NC	-		
AH27	NC	-		
AH29	NC	-		
AH30	NC	-		
AH4	NC	-		
AJ1	NC	-		
AJ2	NC	-		
AJ27	NC	-		
AJ28	NC	-		
AJ29	NC	-		
AJ3	NC	-		
AJ30	NC	-		
AK2	NC	-		
AK27	NC	-		
AK28	NC	-		
AK29	NC	-		
AK3	NC	-		
B1	NC	-		
B2	NC	-		
B3	NC	-		
B30	NC	-		
B4	NC	-		
B5	NC	-		
C1	NC	-		
C2	NC	-		
C29	NC	-		
C30	NC	-		
C4	NC	-		
D13	NC	-		
D18	NC	-		
D23	NC	-		
D28	NC	-		
D29	NC	-		
D3	NC	-		
D30	NC	-		
D4	NC	-		
E25	NC	-		
E26	NC	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N11	CCLK	8			CCLK	8		
M11	INITN	8			INITN	8		
N13	DONE	8			DONE	8		
GNDIO	GNDIO8	-			GNDIO8	-		
M12	PR53B	8	WRITEN	C	PR68B	8	WRITEN	C
M13	PR53A	8	CS1N	T	PR68A	8	CS1N	T
N14	PR52B	8	CSN	C	PR67B	8	CSN	C
N15	PR52A	8	D0/SPIFASTN	T	PR67A	8	D0/SPIFASTN	T
VCCIO	VCCIO8	8			VCCIO8	8		
N16	PR51B	8	D1	C	PR66B	8	D1	C
M16	PR51A	8	D2	T	PR66A	8	D2	T
L12	PR50B	8	D3	C	PR65B	8	D3	C
GNDIO	GNDIO8	-			GNDIO8	-		
L13	PR50A	8	D4	T	PR65A	8	D4	T
L16	PR49B	8	D5	C	PR64B	8	D5	C
K16	PR49A	8	D6	T	PR64A	8	D6	T
L14	PR48B	8	D7/SPID0***	C	PR63B	8	D7/SPID0***	C
VCCIO	VCCIO8	8			VCCIO8	8		
L15	PR48A	8	DI/CSSPI0N	T	PR63A	8	DI/CSSPI0N	T
K13	PR47B	8	DOUT/CSN/CSSPI1N	C	PR62B	8	DOUT/CSN/CSSPI1N	C
K14	PR47A	8	BUSY/SISPI	T	PR62A	8	BUSY/SISPI	T
K11	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
K15	PR45B	3	RLM0_GDLLC_FB_A	C	PR60B	3	RLM0_GDLLC_FB_A/RDQ57	C
GNDIO	GNDIO3	-			GNDIO3	-		
J16	PR45A	3	RLM0_GDLLT_FB_A	T	PR60A	3	RLM0_GDLLT_FB_A/RDQ57	T
H16	PR44B	3	RLM0_GDLLC_IN_A	C (LVDS)*	PR59B	3	RLM0_GDLLC_IN_A**/RDQ57	C (LVDS)*
J15	PR44A	3	RLM0_GDLLT_IN_A	T (LVDS)*	PR59A	3	RLM0_GDLLT_IN_A**/RDQ57	T (LVDS)*
J14	PR43B	3	RLM0_GPLLC_IN_A	C	PR58B	3	RLM0_GPLLC_IN_A**/RDQ57	C
VCCIO	VCCIO3	3			VCCIO3	3		
J13	PR43A	3	RLM0_GPLLT_IN_A	T	PR58A	3	RLM0_GPLLT_IN_A**/RDQ57	T
H13	PR42B	3	RLM0_GPLLC_FB_A	C (LVDS)*	PR57B	3	RLM0_GPLLC_FB_A/RDQ57	C (LVDS)*
H12	PR42A	3	RLM0_GPLLT_FB_A	T (LVDS)*	PR57A	3	RLM0_GPLLT_FB_A/RDQS57***	T (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
VCCIO	VCCIO3	3			VCCIO3	3		
G16	PR32B	3	RLM1_SPLLC_FB_A	C	PR42B	3	RLM2_SPLLC_FB_A	C
VCCIO	VCCIO3	3			VCCIO3	3		
H15	PR32A	3	RLM1_SPLLT_FB_A	T	PR42A	3	RLM2_SPLLT_FB_A	T
E16	PR31B	3	RLM1_SPLLC_IN_A	C (LVDS)*	PR41B	3	RLM2_SPLLC_IN_A	C (LVDS)*
F15	PR31A	3	RLM1_SPLLT_IN_A	T (LVDS)*	PR41A	3	RLM2_SPLLT_IN_A	T (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
VCCIO	VCCIO3	3			VCCIO3	3		
F16	PR28B	3	VREF2_3	C	PR38B	3	VREF2_3	C
G15	PR28A	3	VREF1_3	T	PR38A	3	VREF1_3	T
J11	PR27B	3	PCLKC3_0	C (LVDS)*	PR37B	3	PCLKC3_0	C (LVDS)*
J12	PR27A	3	PCLKT3_0	T (LVDS)*	PR37A	3	PCLKT3_0	T (LVDS)*
G14	PR25B	2	PCLKC2_0/RDQ22	C	PR35B	2	PCLKC2_0/RDQ32	C
G13	PR25A	2	PCLKT2_0/RDQ22	T	PR35A	2	PCLKT2_0/RDQ32	T
GNDIO	GNDIO2	-			GNDIO2	-		

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L4	PL24B	7	LDQ22	C (LVDS)*	PL34B	7	LDQ32	C (LVDS)*	
M1	PL25A	7	PCLKT7_0/LDQ22	T	PL35A	7	PCLKT7_0/LDQ32	T	
GNDIO	GNDIO7	-			GNDIO7	-			
M2	PL25B	7	PCLKC7_0/LDQ22	C	PL35B	7	PCLKC7_0/LDQ32	C	
M6	PL27A	6	PCLKT6_0	T (LVDS)*	PL37A	6	PCLKT6_0	T (LVDS)*	
M5	PL27B	6	PCLKC6_0	C (LVDS)*	PL37B	6	PCLKC6_0	C (LVDS)*	
M3	PL28A	6	VREF2_6	T	PL38A	6	VREF2_6	T	
M4	PL28B	6	VREF1_6	C	PL38B	6	VREF1_6	C	
VCCIO	VCCIO6	6			VCCIO6	6			
N7	PL31A	6	LLM1_SPLLT_IN_A	T (LVDS)*	PL41A	6	LLM2_SPLLT_IN_A	T (LVDS)*	
GNDIO	GNDIO6	-			GNDIO6	-			
N6	PL31B	6	LLM1_SPLLC_IN_A	C (LVDS)*	PL41B	6	LLM2_SPLLC_IN_A	C (LVDS)*	
N1	PL32A	6	LLM1_SPLLT_FB_A	T	PL42A	6	LLM2_SPLLT_FB_A	T	
N2	PL32B	6	LLM1_SPLLC_FB_A	C	PL42B	6	LLM2_SPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
GNDIO	GNDIO6	-			GNDIO6	-			
P6	PL38A	6	LDQS38****	T (LVDS)*	PL48A	6	LDQS48****	T (LVDS)*	
N5	PL38B	6	LDQ38	C (LVDS)*	PL48B	6	LDQ48	C (LVDS)*	
P1	PL39A	6	LDQ38	T	PL49A	6	LDQ48	T	
VCCIO	VCCIO6	6			VCCIO6	6			
P2	PL39B	6	LDQ38	C	PL49B	6	LDQ48	C	
P3	PL40A	6	LDQ38	T (LVDS)*	PL50A	6	LDQ48	T (LVDS)*	
P4	PL40B	6	LDQ38	C (LVDS)*	PL50B	6	LDQ48	C (LVDS)*	
P5	PL41A	6	LDQ38	T	PL51A	6	LDQ48	T	
GNDIO	GNDIO6	-			GNDIO6	-			
P7	PL41B	6	LDQ38	C	PL51B	6	LDQ48	C	
R1	PL42A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL57A	6	LLM0_GPLLT_IN_A**/LDQS57****	T (LVDS)*	
GNDIO	GNDIO6	-			GNDIO6	-			
R2	PL42B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL57B	6	LLM0_GPLLC_IN_A**/LDQ57	C (LVDS)*	
R3	PL43A	6	LLM0_GPLLT_FB_A	T	PL58A	6	LLM0_GPLLT_FB_A/LDQ57	T	
R4	PL43B	6	LLM0_GPLLC_FB_A	C	PL58B	6	LLM0_GPLLC_FB_A/LDQ57	C	
VCCIO	VCCIO6	6			VCCIO6	6			
R6	PL44A	6	LLM0_GDLT_IN_A**	T (LVDS)*	PL59A	6	LLM0_GDLT_IN_A**/LDQ57	T (LVDS)*	
R5	PL44B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL59B	6	LLM0_GDLLC_IN_A**/LDQ57	C (LVDS)*	
T1	PL45A	6	LLM0_GDLT_FB_A	T	PL60A	6	LLM0_GDLT_FB_A/LDQ57	T	
T2	PL45B	6	LLM0_GDLLC_FB_A	C	PL60B	6	LLM0_GDLLC_FB_A/LDQ57	C	
GNDIO	GNDIO6	-			GNDIO6	-			
R7	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
T6	PL47A	6	LDQ51	T (LVDS)*	PL62A	6	LDQ66	T (LVDS)*	
T7	PL47B	6	LDQ51	C (LVDS)*	PL62B	6	LDQ66	C (LVDS)*	
U1	PL48A	6	LDQ51	T	PL63A	6	LDQ66	T	
U2	PL48B	6	LDQ51	C	PL63B	6	LDQ66	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T3	PL49A	6	LDQ51	T (LVDS)*	PL64A	6	LDQ66	T (LVDS)*	
U3	PL49B	6	LDQ51	C (LVDS)*	PL64B	6	LDQ66	C (LVDS)*	
U6	PL50A	6	LDQ51	T	NC	-			
U5	PL50B	6	LDQ51	C	PL65B	6	LDQ66	C	
GNDIO	GNDIO6	-			GNDIO6	-			

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D9	PT45A	0	VREF1_0	T
A2	PT44B	0		C
VCCIO	VCCIO0	0		
A3	PT44A	0		T
B3	PT43B	0		C
C4	PT43A	0		T
E10	PT42B	0		C
F10	PT42A	0		T
C7	PT41B	0		C
GNDIO	GNDIO0	-		
B6	PT41A	0		T
C6	PT40B	0		C
VCCIO	VCCIO0	0		
C5	PT40A	0		T
C8	PT39B	0		C
D8	PT39A	0		T
E8	PT38B	0		C
E9	PT38A	0		T
GNDIO	GNDIO0	-		
VCCIO	VCCIO0	0		
F8	PT10B	0		C
GNDIO	GNDIO0	-		
G8	PT10A	0		T
F7	PT9B	0		C
G7	PT9A	0		T
C3	PT8B	0		C
VCCIO	VCCIO0	0		
D4	PT8A	0		T
F6	PT7B	0		C
E6	PT7A	0		T
E5	PT6B	0		C
D6	PT6A	0		T
D3	PT5B	0		C
GNDIO	GNDIO0	-		
E3	PT5A	0		T
D5	PT4B	0		C
VCCIO	VCCIO0	0		
E4	PT4A	0		T
C2	PT3B	0		C
B2	PT3A	0		T
B1	PT2B	0		C
C1	PT2A	0		T
J10	VCC	-		

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
P8	PL45A	6	LDQ48	T	PL49A	6	LDQ52	T	
R6	PL45B	6	LDQ48	C	PL49B	6	LDQ52	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T1	PL46A	6	LDQ48	T (LVDS)*	PL50A	6	LDQ52	T*	
U1	PL46B	6	LDQ48	C (LVDS)*	PL50B	6	LDQ52	C*	
R7	PL47A	6	LDQ48	T	PL51A	6	LDQ52	T	
T5	PL47B	6	LDQ48	C	PL51B	6	LDQ52	C	
GNDIO	GNDIO6	-			GNDIO6	-			
U3	PL48A	6	LDQS48	T (LVDS)*	PL52A	6	LDQS52	T*	
U4	PL48B	6	LDQ48	C (LVDS)*	PL52B	6	LDQ52	C*	
U5	PL49A	6	LDQ48	T	PL53A	6	LDQ52	T	
VCCIO	VCCIO6	6			VCCIO6	6			
U6	PL49B	6	LDQ48	C	PL53B	6	LDQ52	C	
U2	PL50A	6	LDQ48	T (LVDS)*	PL54A	6	LDQ52	T*	
V1	PL50B	6	LDQ48	C (LVDS)*	PL54B	6	LDQ52	C*	
W2	PL51A	6	LDQ48	T	PL55A	6	LDQ52	T	
GNDIO	GNDIO6	-			GNDIO6	-			
V2	PL51B	6	LDQ48	C	PL55B	6	LDQ52	C	
V4	PL55A	6	LDQ57	T (LVDS)*	PL59A	6		T*	
VCCIO	VCCIO6	6			VCCIO6	6			
V3	PL55B	6	LDQ57	C (LVDS)*	PL59B	6		C*	
-	-	-			GNDIO6	-			
W4	PL57A	6	LLM0_GPLLT_IN_A**/LDQS57****	T (LVDS)*	PL62A	6	LLM0_GPLLT_IN_A	T*	
GNDIO	GNDIO6	-			GNDIO6	-			
W3	PL57B	6	LLM0_GPLLC_IN_A**/LDQ57	C (LVDS)*	PL62B	6	LLM0_GPLLC_IN_A	C*	
W1	PL58A	6	LLM0_GPLLT_FB_A/LDQ57	T	PL63A	6	LLM0_GPLLT_FB_A	T	
Y1	PL58B	6	LLM0_GPLLC_FB_A/LDQ57	C	PL63B	6	LLM0_GPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
AA1	PL59A	6	LLM0_GDLLT_IN_A**/LDQ57	T (LVDS)*	PL64A	6	LLM0_GDLLT_IN_A	T*	
AB1	PL59B	6	LLM0_GDLLC_IN_A**/LDQ57	C (LVDS)*	PL64B	6	LLM0_GDLLC_IN_A	C*	
U7	PL60A	6	LLM0_GDLLT_FB_A/LDQ57	T	PL65A	6	LLM0_GDLLT_FB_A	T	
V6	PL60B	6	LLM0_GDLLC_FB_A/LDQ57	C	PL65B	6	LLM0_GDLLC_FB_A	C	
GNDIO	GNDIO6	-			GNDIO6	-			
T8	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
W5	PL62A	6	LDQ66	T (LVDS)*	PL67A	6	LDQ71	T*	
Y4	PL62B	6	LDQ66	C (LVDS)*	PL67B	6	LDQ71	C*	
U8	PL63A	6	LDQ66	T	PL68A	6	LDQ71	T	
W6	PL63B	6	LDQ66	C	PL68B	6	LDQ71	C	
VCCIO	VCCIO6	6			VCCIO6	6			
Y3	PL64A	6	LDQ66	T (LVDS)*	PL69A	6	LDQ71	T*	
AA3	PL64B	6	LDQ66	C (LVDS)*	PL69B	6	LDQ71	C*	
V7	NC	-			PL70A	6	LDQ71	T	
Y5	PL65B	6	LDQ66	C	PL70B	6	LDQ71	C	
GNDIO	GNDIO6	-			GNDIO6	-			
AB2	PL66A	6	LDQS66	T (LVDS)*	PL71A	6	LDQS71	T*	
AA4	PL66B	6	LDQ66	C (LVDS)*	PL71B	6	LDQ71	C*	
Y6	PL67A	6	LDQ66	T	PL72A	6	LDQ71	T	
VCCIO	VCCIO6	6			VCCIO6	6			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AF4	PB17B	5	BDQ15	C	PB17B	5	BDQ15	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AF5	PB18A	5	BDQ15	T	PB18A	5	BDQ15	T	
AF6	PB18B	5	BDQ15	C	PB18B	5	BDQ15	C	
Y12	PB19A	5	BDQ15	T	PB19A	5	BDQ15	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AB11	PB19B	5	BDQ15	C	PB19B	5	BDQ15	C	
-	-	-			VCCIO5	5			
-	-	-			GNDIO5	-			
AD7	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T	
AF7	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C	
AD8	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T	
AA12	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C	
AE8	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AF8	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C	
AD9	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T	
AC10	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C	
AC11	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AB12	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C	
AD10	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T	
Y13	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C	
AF9	PB26A	5	BDQ24	T	PB35A	5	BDQ33	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AE9	PB26B	5	BDQ24	C	PB35B	5	BDQ33	C	
AF10	PB27A	5	BDQ24	T	PB36A	5	BDQ33	T	
AE10	PB27B	5	BDQ24	C	PB36B	5	BDQ33	C	
AD11	PB28A	5	BDQ24	T	PB37A	5	BDQ33	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AF11	PB28B	5	BDQ24	C	PB37B	5	BDQ33	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GNDIO	GNDIO5	-			GNDIO5	-			
AA13	PB33A	5	BDQS33****	T	PB42A	5	BDQS42****	T	
AB13	PB33B	5	BDQ33	C	PB42B	5	BDQ42	C	
W14	PB34A	5	VREF2_5/BDQ33	T	PB43A	5	VREF2_5/BDQ42	T	
AC12	PB34B	5	VREF1_5/BDQ33	C	PB43B	5	VREF1_5/BDQ42	C	
AF12	PB35A	5	PCLKT5_0/BDQ33	T	PB44A	5	PCLKT5_0/BDQ42	T	
AD12	PB35B	5	PCLKC5_0/BDQ33	C	PB44B	5	PCLKC5_0/BDQ42	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GNDIO	GNDIO5	-			GNDIO5	-			
AC13	PB40A	4	PCLKT4_0/BDQ42	T	PB49A	4	PCLKT4_0/BDQ51	T	
VCCIO	VCCIO4	4			VCCIO4	4			
Y14	PB40B	4	PCLKC4_0/BDQ42	C	PB49B	4	PCLKC4_0/BDQ51	C	
AB20	PB57A	4	BDQ60	T	PB50A	4	VREF2_4/BDQ51	T	
AC14	PB41B	4	VREF1_4/BDQ42	C	PB50B	4	VREF1_4/BDQ51	C	
AB14	PB42A	4	BDQS42****	T	PB51A	4	BDQS51****	T	
GNDIO	GNDIO4	-			GNDIO4	-			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
T18	VCCAUX	-			VCCAUX	-			
T9	VCCAUX	-			VCCAUX	-			
V11	VCCAUX	-			VCCAUX	-			
V12	VCCAUX	-			VCCAUX	-			
V15	VCCAUX	-			VCCAUX	-			
V16	VCCAUX	-			VCCAUX	-			
A13	GND	-			GND	-			
A19	GND	-			GND	-			
A2	GND	-			GND	-			
A25	GND	-			GND	-			
AA2	GND	-			GND	-			
AA25	GND	-			GND	-			
AB18	GND	-			GND	-			
AB22	GND	-			GND	-			
AB5	GND	-			GND	-			
AB9	GND	-			GND	-			
AE1	GND	-			GND	-			
AE11	GND	-			GND	-			
AE16	GND	-			GND	-			
AE22	GND	-			GND	-			
AE26	GND	-			GND	-			
AE6	GND	-			GND	-			
AF13	GND	-			GND	-			
AF19	GND	-			GND	-			
AF2	GND	-			GND	-			
AF25	GND	-			GND	-			
B1	GND	-			GND	-			
B11	GND	-			GND	-			
B16	GND	-			GND	-			
B22	GND	-			GND	-			
B26	GND	-			GND	-			
B6	GND	-			GND	-			
E18	GND	-			GND	-			
E22	GND	-			GND	-			
E5	GND	-			GND	-			
E9	GND	-			GND	-			
F2	GND	-			GND	-			
F25	GND	-			GND	-			
G11	GND	-			GND	-			
G16	GND	-			GND	-			
J22	GND	-			GND	-			
J5	GND	-			GND	-			
K11	GND	-			GND	-			
K13	GND	-			GND	-			
K14	GND	-			GND	-			
K16	GND	-			GND	-			
L10	GND	-			GND	-			
L11	GND	-			GND	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AJ2	LLC_SQ_HDINN3	14		C
AH4	LLC_SQ_VCCTX3	14		
AK5	LLC_SQ_HDOUTP3	14		T
AK4	LLC_SQ_VCCOB3	14		
AJ5	LLC_SQ_HDOUTN3	14		C
AH5	LLC_SQ_VCCTX2	14		
AJ6	LLC_SQ_HDOUTN2	14		C
AH6	LLC_SQ_VCCOB2	14		
AK6	LLC_SQ_HDOUTP2	14		T
AH2	LLC_SQ_VCCR2	14		
AJ3	LLC_SQ_HDINN2	14		C
AH3	LLC_SQ_VCCIB2	14		
AK3	LLC_SQ_HDINP2	14		T
AH7	LLC_SQ_VCCP	14		
AG7	LLC_SQ_REFCLKP	14		T
AF7	LLC_SQ_REFCLKN	14		C
AJ7	LLC_SQ_VCCAUX33	14		
AK11	LLC_SQ_HDINP1	14		T
AH11	LLC_SQ_VCCIB1	14		
AJ11	LLC_SQ_HDINN1	14		C
AH12	LLC_SQ_VCCR1	14		
AK8	LLC_SQ_HDOUTP1	14		T
AH8	LLC_SQ_VCCOB1	14		
AJ8	LLC_SQ_HDOUTN1	14		C
AH9	LLC_SQ_VCCTX1	14		
AJ9	LLC_SQ_HDOUTN0	14		C
AK10	LLC_SQ_VCCOB0	14		
AK9	LLC_SQ_HDOUTP0	14		T
AH10	LLC_SQ_VCCTX0	14		
AJ12	LLC_SQ_HDINN0	14		C
AJ13	LLC_SQ_VCCIB0	14		
AK12	LLC_SQ_HDINP0	14		T
AH13	LLC_SQ_VCCR0	14		
AF10	PB30A	5	BDQ33	T
AE8	PB30B	5	BDQ33	C
AE11	PB31A	5	BDQ33	T
VCCIO	VCCIO5	5		
AD9	PB31B	5	BDQ33	C
AE10	PB32A	5	BDQ33	T
AD10	PB32B	5	BDQ33	C
AE13	PB33A	5	BDQS33	T
GNDIO	GNDIO5	-		
AC12	PB33B	5	BDQ33	C

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
U15	GND	-		
U16	GND	-		
U17	GND	-		
U18	GND	-		
U20	GND	-		
V14	GND	-		
V15	GND	-		
V16	GND	-		
V17	GND	-		
V27	GND	-		
V4	GND	-		
W23	GND	-		
W8	GND	-		
Y14	GND	-		
Y15	GND	-		
Y16	GND	-		
Y17	GND	-		
AA26	NC	-		
AB10	NC	-		
AB11	NC	-		
AB12	NC	-		
AB13	NC	-		
AB14	NC	-		
AB15	NC	-		
AB16	NC	-		
AB17	NC	-		
AB19	NC	-		
AB20	NC	-		
AB21	NC	-		
AB9	NC	-		
AC10	NC	-		
AC11	NC	-		
AC21	NC	-		
AC22	NC	-		
AC8	NC	-		
AC9	NC	-		
AD21	NC	-		
AD22	NC	-		
AD4	NC	-		
AD5	NC	-		
AD6	NC	-		
AD7	NC	-		
AD8	NC	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
P31	NC	-			PR39B	2		C (LVDS)*
P32	NC	-			PR39A	2		T (LVDS)*
R25	NC	-			PR38B	2		C
-	-	-			VCCIO2	2		
T24	NC	-			PR38A	2		T
N34	NC	-			PR37B	2		C (LVDS)*
N33	NC	-			PR37A	2		T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		
M34	PR31B	2	RDQ28	C	PR35B	2	RDQ32	C
M33	PR31A	2	RDQ28	T	PR35A	2	RDQ32	T
-	-	-			GNDIO2	-		
R24	PR30B	2	RDQ28	C (LVDS)*	PR34B	2	RDQ32	C (LVDS)*
P24	PR30A	2	RDQ28	T (LVDS)*	PR34A	2	RDQ32	T (LVDS)*
N30	PR29B	2	RDQ28	C	PR33B	2	RDQ32	C
M29	PR29A	2	RDQ28	T	PR33A	2	RDQ32	T
VCCIO	VCCIO2	2			VCCIO2	2		
N28	PR28B	2	RDQ28	C (LVDS)*	PR32B	2	RDQ32	C (LVDS)*
N29	PR28A	2	RDQS28	T (LVDS)*	PR32A	2	RDQS32	T (LVDS)*
N24	PR27B	2	RDQ28	C	PR31B	2	RDQ32	C
GNDIO	GNDIO2	-			GNDIO2	-		
N25	PR27A	2	RDQ28	T	PR31A	2	RDQ32	T
M28	PR26B	2	RDQ28	C (LVDS)*	PR30B	2	RDQ32	C (LVDS)*
M27	PR26A	2	RDQ28	T (LVDS)*	PR30A	2	RDQ32	T (LVDS)*
L27	PR25B	2	RDQ28	C	PR29B	2	RDQ32	C
VCCIO	VCCIO2	2			VCCIO2	2		
M26	PR25A	2	RDQ28	T	PR29A	2	RDQ32	T
M32	PR24B	2	RDQ28	C (LVDS)*	PR28B	2	RDQ32	C (LVDS)*
M31	PR24A	2	RDQ28	T (LVDS)*	PR28A	2	RDQ32	T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		
-	-	-			VCCIO2	2		
L34	PR22B	2		C	PR22B	2	RDQ23	C
L33	PR22A	2		T	PR22A	2	RDQ23	T
L32	PR21B	2		C (LVDS)*	PR21B	2	RDQ23	C (LVDS)*
L31	PR21A	2		T (LVDS)*	PR21A	2	RDQ23	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
L28	PR20B	2		C	PR20B	2	RDQ23	C
L29	PR20A	2		T	PR20A	2	RDQ23	T
M30	PR19B	2		C (LVDS)*	PR19B	2	RDQ23	C (LVDS)*
L30	PR19A	2		T (LVDS)*	PR19A	2	RDQ23	T (LVDS)*
K34	PR18B	2	RDQ15	C	PR18B	2	RDQ15	C
K33	PR18A	2	RDQ15	T	PR18A	2	RDQ15	T
GNDIO	GNDIO2	-			GNDIO2	-		
K30	PR17B	2	RDQ15	C (LVDS)*	PR17B	2	RDQ15	C (LVDS)*
K29	PR17A	2	RDQ15	T (LVDS)*	PR17A	2	RDQ15	T (LVDS)*
J34	PR16B	2	RDQ15	C	PR16B	2	RDQ15	C
J33	PR16A	2	RDQ15	T	PR16A	2	RDQ15	T
VCCIO	VCCIO2	2			VCCIO2	2		
J32	PR15B	2	RDQ15	C (LVDS)*	PR15B	2	RDQ15	C (LVDS)*
J31	PR15A	2	RDQS15	T (LVDS)*	PR15A	2	RDQS15	T (LVDS)*

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F21	GND	-			GND	-		
G31	GND	-			GND	-		
G4	GND	-			GND	-		
J12	GND	-			GND	-		
J16	GND	-			GND	-		
J19	GND	-			GND	-		
J23	GND	-			GND	-		
K27	GND	-			GND	-		
K31	GND	-			GND	-		
K4	GND	-			GND	-		
K8	GND	-			GND	-		
M16	GND	-			GND	-		
M17	GND	-			GND	-		
M18	GND	-			GND	-		
M19	GND	-			GND	-		
N16	GND	-			GND	-		
N17	GND	-			GND	-		
N18	GND	-			GND	-		
N19	GND	-			GND	-		
N26	GND	-			GND	-		
N31	GND	-			GND	-		
N4	GND	-			GND	-		
N9	GND	-			GND	-		
R16	GND	-			GND	-		
R17	GND	-			GND	-		
R18	GND	-			GND	-		
R19	GND	-			GND	-		
T12	GND	-			GND	-		
T13	GND	-			GND	-		
T15	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T18	GND	-			GND	-		
T19	GND	-			GND	-		
T20	GND	-			GND	-		
T22	GND	-			GND	-		
T23	GND	-			GND	-		
T26	GND	-			GND	-		
T31	GND	-			GND	-		
T4	GND	-			GND	-		
T9	GND	-			GND	-		
U12	GND	-			GND	-		
U13	GND	-			GND	-		
U15	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
U18	GND	-			GND	-		
U19	GND	-			GND	-		
U20	GND	-			GND	-		

LatticeECP2 Standard Series Devices, Conventional Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5T144C	90	1.2V	-5	TQFP	144	COM	6
LFE2-6E-6T144C	90	1.2V	-6	TQFP	144	COM	6
LFE2-6E-7T144C	90	1.2V	-7	TQFP	144	COM	6
LFE2-6E-5F256C	190	1.2V	-5	fpBGA	256	COM	6
LFE2-6E-6F256C	190	1.2V	-6	fpBGA	256	COM	6
LFE2-6E-7F256C	190	1.2V	-7	fpBGA	256	COM	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5T144C	93	1.2V	-5	TQFP	144	COM	12
LFE2-12E-6T144C	93	1.2V	-6	TQFP	144	COM	12
LFE2-12E-7T144C	93	1.2V	-7	TQFP	144	COM	12
LFE2-12E-5Q208C	131	1.2V	-5	PQFP	208	COM	12
LFE2-12E-6Q208C	131	1.2V	-6	PQFP	208	COM	12
LFE2-12E-7Q208C	131	1.2V	-7	PQFP	208	COM	12
LFE2-12E-5F256C	193	1.2V	-5	fpBGA	256	COM	12
LFE2-12E-6F256C	193	1.2V	-6	fpBGA	256	COM	12
LFE2-12E-7F256C	193	1.2V	-7	fpBGA	256	COM	12
LFE2-12E-5F484C	297	1.2V	-5	fpBGA	484	COM	12
LFE2-12E-6F484C	297	1.2V	-6	fpBGA	484	COM	12
LFE2-12E-7F484C	297	1.2V	-7	fpBGA	484	COM	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208C	131	1.2V	-5	PQFP	208	COM	20
LFE2-20E-6Q208C	131	1.2V	-6	PQFP	208	COM	20
LFE2-20E-7Q208C	131	1.2V	-7	PQFP	208	COM	20
LFE2-20E-5F256C	193	1.2V	-5	fpBGA	256	COM	20
LFE2-20E-6F256C	193	1.2V	-6	fpBGA	256	COM	20
LFE2-20E-7F256C	193	1.2V	-7	fpBGA	256	COM	20
LFE2-20E-5F484C	331	1.2V	-5	fpBGA	484	COM	20
LFE2-20E-6F484C	331	1.2V	-6	fpBGA	484	COM	20
LFE2-20E-7F484C	331	1.2V	-7	fpBGA	484	COM	20
LFE2-20E-5F672C	402	1.2V	-5	fpBGA	672	COM	20
LFE2-20E-6F672C	402	1.2V	-6	fpBGA	672	COM	20
LFE2-20E-7F672C	402	1.2V	-7	fpBGA	672	COM	20